

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Masato TANAKA</td> <td>04/11/2013</td> </tr> <tr> <td>Kazuo ASANUMA</td> <td>04/10/2013</td> </tr> <tr> <td>Yasuo HOSAKA</td> <td>04/15/2013</td> </tr> <tr> <td>Hirokazu SHIRAKAWA</td> <td>04/10/2013</td> </tr> </tbody> </table>		Name	Execution Date	Masato TANAKA	04/11/2013	Kazuo ASANUMA	04/10/2013	Yasuo HOSAKA	04/15/2013	Hirokazu SHIRAKAWA	04/10/2013
Name	Execution Date										
Masato TANAKA	04/11/2013										
Kazuo ASANUMA	04/10/2013										
Yasuo HOSAKA	04/15/2013										
Hirokazu SHIRAKAWA	04/10/2013										
RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>MICROSPACE CORPORATION</td> </tr> <tr> <td>Street Address:</td> <td>7-14-402, Kitashinagawa 5-chome, Shinagawa-ku</td> </tr> <tr> <td>City:</td> <td>Tokyo</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>141-0001</td> </tr> </table>		Name:	MICROSPACE CORPORATION	Street Address:	7-14-402, Kitashinagawa 5-chome, Shinagawa-ku	City:	Tokyo	State/Country:	JAPAN	Postal Code:	141-0001
Name:	MICROSPACE CORPORATION										
Street Address:	7-14-402, Kitashinagawa 5-chome, Shinagawa-ku										
City:	Tokyo										
State/Country:	JAPAN										
Postal Code:	141-0001										
<table border="1"> <tr> <td>Name:</td> <td>TAIYO YUDEN CO., LTD.</td> </tr> <tr> <td>Street Address:</td> <td>16-20, Ueno 6-chome, Taito-ku</td> </tr> <tr> <td>City:</td> <td>Tokyo</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>110-0005</td> </tr> </table>		Name:	TAIYO YUDEN CO., LTD.	Street Address:	16-20, Ueno 6-chome, Taito-ku	City:	Tokyo	State/Country:	JAPAN	Postal Code:	110-0005
Name:	TAIYO YUDEN CO., LTD.										
Street Address:	16-20, Ueno 6-chome, Taito-ku										
City:	Tokyo										
State/Country:	JAPAN										
Postal Code:	110-0005										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13851308</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13851308						
Property Type	Number										
Application Number:	13851308										
CORRESPONDENCE DATA											
Fax Number:	2402382825										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
Phone:	408-530-8033										
Email:	patents@cyiplaw.com										
Correspondent Name:	Masao Yoshimura, Chen Yoshimura LLP										
Address Line 1:	333 W. El Camino Real										

OP \$40.00 13851308

Address Line 2: Suite 380
Address Line 4: Sunnyvale, CALIFORNIA 94087

ATTORNEY DOCKET NUMBER:	88249.JP11-0373-US
NAME OF SUBMITTER:	Maiko Kuwada
Signature:	/Maiko Kuwada/
Date:	04/22/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 2 source=JP11-0373-US_Declaration-Assignment#page1.tif source=JP11-0373-US_Declaration-Assignment#page2.tif	

**COMBINED DECLARATION AND ASSIGNMENT
FOR UTILITY APPLICATION**

**Title of
Invention**

MOTOR DRIVE CONTROL DEVICE

DECLARATION

As a below named inventor, I hereby declare that:

This declaration
is directed to:

The attached application, or

United States application or PCT international application
number 13/851,308 filed on March 27, 2013.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNMENT

WHEREAS, MICROSPACE CORPORATION, a corporation of Japan, whose post office address is 7-14-402, Kitashinagawa 5-chome, Shinagawa-ku, Tokyo 141-0001, Japan (hereinafter referred to as MICROSPACE), and TAIYO YUDEN CO., LTD., a corporation of Japan, whose post office address is 16-20, Ueno 6-chome, Taito-ku, Tokyo 110-0005, Japan (hereinafter referred to as TAIYO YUDEN) (MICROSPACE and TAIYO YUDEN are collectively referred to as Assignee hereinafter) are desirous of securing collectively the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/WE have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto MICROSPACE, its lawful successors and assigns, 20% of MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and further, I/WE have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto TAIYO YUDEN, its lawful successors and assigns, 80% of MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration,

communicate with Assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Power of Attorney in this application, to insert here in parenthesis (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Legal Name of Sole or First Inventor Masato TANAKA	
Signature <i>Masato Tanaka</i>	Date April 11, 2013
Legal Name of Second Inventor Kazuo ASANUMA	
Signature <i>Kazuo ASANUMA</i>	Date April 10, 2013
Legal Name of Third Inventor Yasuo HOSAKA	
Signature <i>Yasuo HOSAKA</i>	Date April 15, 2013
Legal Name of Fourth Inventor Hirokazu SHIRAKAWA	
Signature <i>Hirokazu SHIRAKAWA</i>	Date April 10, 2013